

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	81855	indium	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/05 19:10
L2	387601	heat with (spreader dissipate sink slug clover lid metal)	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/05 19:11
L3	3095	1 with solder	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/05 19:11
L4	770	2 and 3	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/05 19:11
L5	10	4 and (encapsulate encapsulation encase encasing)	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/05 19:12
L6	98	4 and (encapsulate encapsulation encase encasing)	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/05 19:13

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L4	770	2 and 3	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/05 19:27
L5	10	4 and (encapsulate encapsulation encase encasing)	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/05 19:12
L6	98	4 and (encapsulate encapsulation encase encasing)	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/05 19:13
L7	377	4 and (epoxy resin)	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/05 19:27
L8	300	7 not 6	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/05 19:27